R4Y, THB Grade IIB, Class Y1, 500 VAC, 125°C (Automotive Grade)



Overview

The R4Y is constructed of metallized polypropylene film, encapsulated with self-extinguishing resin, in a box of material meeting the requirements of UL 94 V-0.

Automotive Grade devices meet the demanding Automotive Electronics Council's AEC-Q200 qualification requirements.

Applications

For use in electromagnetic interference (EMI) suppression filter in "line-to-ground" applications, requiring Y1 safety classification. Suitable for use in situations where failure of the capacitor could lead to danger of electric shock.

Benefits

· Approvals: ENEC, UL, cUL, CQC

Class Y1 (IEC 60384-14)

 THB Grade IIB: 85°C, 85% RH, 500 hours at 500 V URAC, acc. to IEC 60384-14

· Rated voltage: 500 VAC 50/60 Hz

• Capacitance range: $0.00047 - 0.033 \mu F$

Lead spacing: 15 – 22.5 mm

• Capacitance tolerance: ±20%, ±10%

Climatic category 40/110/56, IEC 60068-1

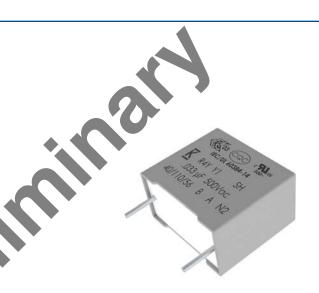
Tape and reel in accordance with IEC 60286-2

· RoHS compliant and lead-free terminations

Operating temperature range of -40°C to +125°C

Self-healing properties

· Automotive (AEC-Q200) grade



Part Number System

R4Y	5	I	2100	00	00	M
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Packaging	Internal Use	Capacitance Tolerance
Y1, Metallized Polypropylene	5 = 500	I = 15.0 N = 22.5	The last three digits represent significant figures. The first digit specifies number of zeros to be added.	See Ordering Options Table	00	K = ±10% M = ±20%



Ordering Options Table

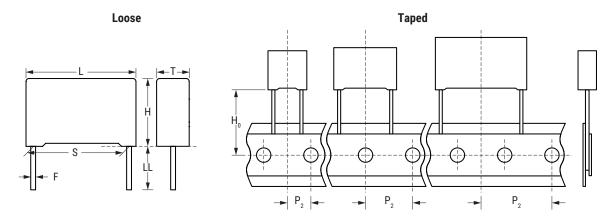
Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	Lead and Packaging Code
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4 +2/-0	00
	Ammo Pack	H ₀ = 18.5 ±0.5	DQ ¹
	Other Lead and Packaging Options		
15	Tape & Reel (Large Reel)	H ₀ = 18.5 ±0.5	CK
15	Tape & Reel (Standard Reel)	H ₀ = 18.5 ±0.5	GY
22.5	Pizza-Short Leads	3.2 +0.3/-0.2	НА
	Bulk (Bag) ² – Short Leads	3.5 +0.5/-0	JB
	Bulk (Bag) ² – Short Leads	4.0 +0.5/-0	JE
	Bulk (Bag) ² – Short Leads	3.2 +0.3/-0.2	JH.
	Bulk (Bag) – Long Leads	18 ±1	JM
	Bulk (Bag) – Long Leads	30 +5/-0	40
	Bulk (Bag) – Long Leads	25 +2/-1	.50

¹ Not for all sizes, see "Packaging Quantities" table

² For lead spacing 22.5 case sizes \geq 8.5*17*26.5 the parts are packed in a Pizza box 335*320*34 mm



Dimensions - Millimeters



	S		Γ	Н		L			
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
15.0	±0.4	5.0	+0.2/-0.5	11.0	+0.1/-0.5	18.0	+0.3/-0.5	0.8	±0.05
15.0	±0.4	6.0	+0.2/-0.5	12.0	+0.1/-0.5	18.0	+0.3/-0.5	0.8	±0.05
15.0	±0.4	7.5	+0.2/-0.5	13.5	+0.1/-0.5	18.0	+0.3/-0.5	0.8	±0.05
15.0	±0.4	8.5	+0.2/-0.5	14.5	+0.1/-0.5	18.0	+0.3/-0.5	0.8	±0.05
15.0	±0.4	10.0	+0.2/-0.5	16.0	+0.1/-0.5	18.0	+0.3/-0.5	0.8	±0.05
15.0	±0.4	11.0	+0.2/-0.5	19.0	+0.1/-0.5	18.0	+0.3/-0.5	0.8	±0.05
22.5	±0.4	6.0	+0.2/-0.5	15.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	7.0	+0.2/-0.5	16.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	8.5	+0.2/-0.5	17.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	10.0	+0.2/-0.5	18.5	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	11.0	+0.2/-0.5	20.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	13.0	+0.2/-0.5	22.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
	•	Note: Se	e Ordering O	ptions Tabl	e for lead ler	nath (LL/H.)	options.	•	·



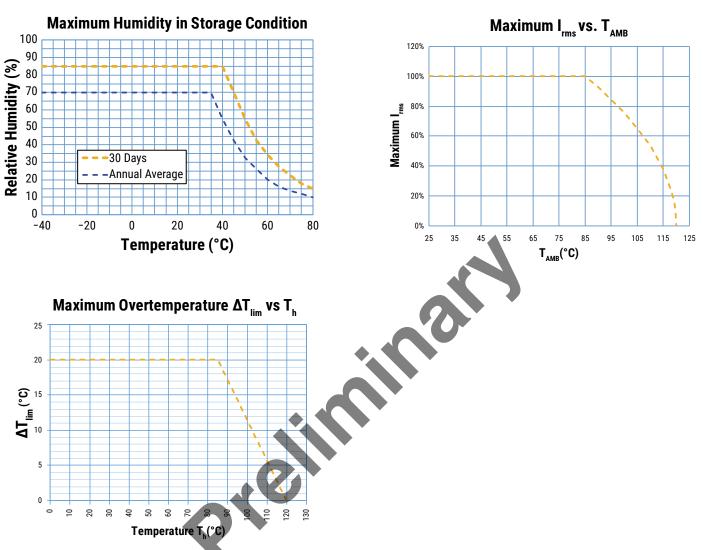
Performance Characteristics

Dielectric	Polypropylene film	Polypropylene film						
Plates	Metal layer deposited by evaporation under vacum							
Winding	Non-inductive type							
Leads	Tinned wire							
Protection	Plastic case, thermosetting	g resin filled. Box material is s	olvent resistant and flame ret	ardant according to UL 94				
Related Documents	IEC 60384-14, EN 60384-	-14						
Rated Voltage V _R	500 VAC (50/60 Hz)							
Maximum Continuous AC Voltage	750 VAC (50/60 Hz) (1,0	00 h)						
Maximum Continuous DC Voltage	3,000 VDC at 85°C (1,000) h), +85°C to +125°C, 1.5% /	°C derating					
Capacitance Range	0.00047 - 0.033 μF							
Capacitance Values	E6 series (IEC 60063)							
Capacitance Tolerance	±10%, ±20%							
Temperature Range	-40°C to +125°C	9						
Climatic Category	40/110/56 IEC 60068-1	.00						
Reliability	Operational life at rated	voltage: 100,000 hours at 85	5°C; 2,000 hours at 125°C					
	Storage time: ≤ 24 month	ns from the date marked on	the label package					
	Average relative humidity	y per year ≤ 70%						
Storage Conditions	RH ≤ 85% for 30 days ran	domly distributed througho	ut the year					
	Dew is absent							
	Temperature: -40 to 80°	C (see "Maximum Humidity	in Storage Conditions" grap	h below)				
Approvals	ENEC, UL, cUL, CQC							
		Maximum Value	es at +25°C ±5°C					
Dissipation Factor (tanδ) at 1 kHz	Pitch =	15 mm	Pitch = :	22.5 mm				
	1.0	0%	0.	6%				
		Measured at	t +25°C ±5°C					
		Minimum Values E	Between Terminals					
Insulation Resistance	Voltage Charge	Voltage Charge Time	C ≤ 0.33 µF					
	500 VDC	1 minute	$\geq 1 \cdot 10^5 \mathrm{M}\Omega$ ($\geq 5 \cdot 10^5 \mathrm{M}\Omega$)*					
	l .		(≤ 0 - 10, ΙΔΙΩ)					

^{*} Typical value



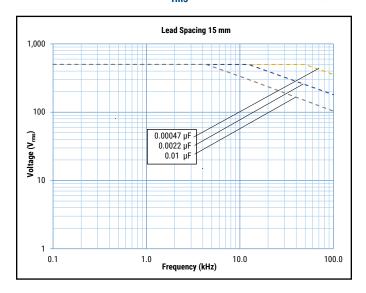
Performance Characteristics cont.

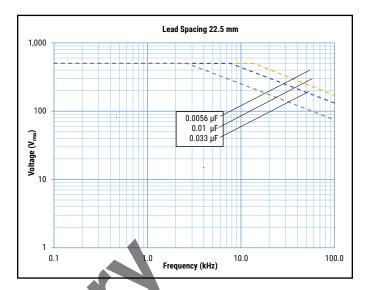


 T_h is the maximum ambient temperature surrounding the capacitor or hottest contact point (e.g. tracks), whichever is higher, in the worst operation conditions in °C.

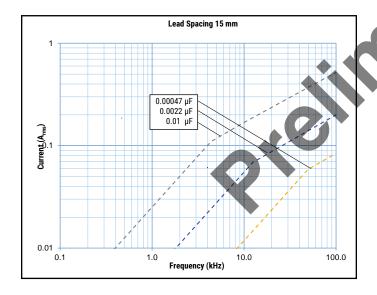


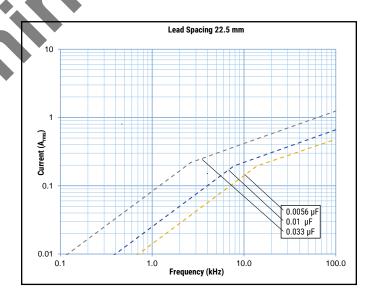
Maximum Voltage (V_{rms}) Versus Frequency (Sinusoidal Waveform/Th ≤ 85 °C)





Maximum Current (I_{rms}) Versus Frequency (Sinusoidal Waveform/Th ≤ 85 °C)







Qualification

Automotive grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC-Q200, please visit their website at www.aecouncil.com.

Environmental Test Data

Test	IEC Publication	Procedure
Endurance	IEC 60384-14	1.7 x V_R VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature (110°C)
Vibration	MIL-STD-202 Method 204	5 G for 20 minutes, 12 cycles each of 3 orientations. Use 8"X5" PCB, 0.031" thick. 7 secure points on one 8" side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from $10 - 2,000$ Hz.
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213. Condition C
Temperature Cycling	JESD22-Method JA-104	1,000 cycles (-40°C to 110°C) Note: Measurement at 24 ±4 hours after test conclusion. 30 minute maximum dwell time at each temperature extreme. 1 minute maximum transition time.
Passive Flammability	IEC 60384-14	IEC 60384-1, IEC 60695-11-5 Needle Flame Test
Biased Humidity	According to IEC 60384-14 Grade (IB	85°C, 85% RH and 500 VAC, 500 hours Capacitance change (Δ C/C): \leq 10% Dissipation factor change (Δ tanδ): \leq 150 * 10 ⁻⁴ (at 1 kHz for Cap > 1 μF) Dissipation factor change (Δ tanδ): \leq 240 * 10 ⁻⁴ (at 10 kHz for Cap \leq 1 μF) IR \geq 50% of initial limit or minimum 200 MΩ

Approvals

Certification Body	Mark	Specification	File Number
IMQ S.p.A.		EN/IEC 60384-14	Pending
UL	c FU ®us	UL 60384-14 and CAN/CSA E60384-14	Pending
cqc	cec	IEC 60384-14	Pending



Environmental Compliance



Table 1 - Ratings & Part Number Reference

Capacitance	Capacitance Dimensions in mm Lead Spacing		dV/dt	KEMET	Customer		
Value (µF)	Т	Н	L	(S)	(V/µs)	Part Number	Part Number
0.00047	5.0	11.0	18.0	15.0	3000	4Y5I0470(1)00(2)	R4Y5I0470(1)00(2)
0.00068	5.0	11.0	18.0	15.0	3000	4Y5I0680(1)00(2)	R4Y5I0680(1)00(2)
0.001	5.0	11.0	18.0	15.0	3000	4Y5I1100(1)00(2)	R4Y5I1100(1)00(2)
0.0015	5.0	11.0	18.0	15.0	3000	4Y5I1150(1)00(2)	R4Y5I1150(1)00(2)
0.0022	6.0	12.0	18.0	15.0	3000	4Y5I1220(1)00(2)	R4Y5I1220(1)00(2)
0.0033	7.5	13.5	18.0	15.0	3000	4Y5I1330(1)00(2)	R4Y5I1330(1)00(2)
0.0047	8.5	14.5	18.0	15.0	3000	4Y5I1470(1)00(2)	R4Y5I1470(1)00(2)
0.0068	10.0	16.0	18.0	15.0	3000	4Y5I1680(1)00(2)	R4Y5I1680(1)00(2)
0.01	11.0	19.0	18.0	15.0	3000	4Y5I2100(1)00(2)	R4Y5I2100(1)00(2)
0.0056	6.0	15.0	26.5	22.5	1000	4Y5N1560(1)00(2)	R4Y5N1560(1)00(2)
0.0068	7.0	16.0	26.5	22.5	1000	4Y5N1680(1)00(2)	R4Y5N1680(1)00(2)
0.01	8.5	17.0	26.5	22.5	1000	4Y5N2100(1)00(2)	R4Y5N2100(1)00(2)
0.015	10.0	18.5	26.5	22.5	1000	4Y5N2150(1)00(2)	R4Y5N2150(1)00(2)
0.022	11.0	20.0	26.5	22.5	1000	4Y5N2220(1)00(2)	R4Y5N2220(1)00(2)
0.033	13.0	22.0	26.5	22.5	1000	4Y5N2330(1)00(2)	R4Y5N2330(1)00(2)
Capacitance Value (µF)	T (mm)	H (mm)	L (mm)	Lead Spacing (S)	dV/dt (V/μs)	KEMET Part Number	Customer Part Number

⁽¹⁾ Insert lead and packaging code. See Ordering Options Table for available options.

⁽²⁾ $M = \pm 20\%$, $K = \pm 10\%$



Soldering Process

The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183°C for SnPb eutectic alloy to 217 – 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 mm to 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

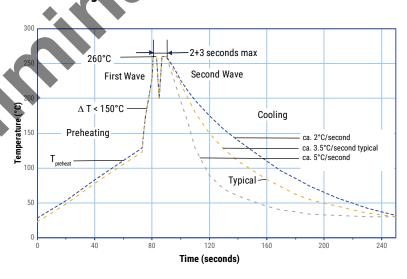
Manual Soldering Recommendations

The following is the recommendation for manual soldering with a soldering iron.

Recommended Soldering Temperature

The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations



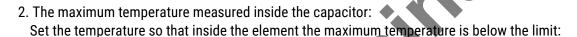


Soldering Process cont.

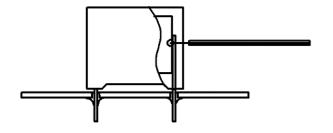
Wave Soldering Recommendations cont.

1. The table indicates the maximum set-up temperature of the soldering process Figure 1

Dielectric	Maxi Prel Tempe	neat	Maximum Peak Soldering Temperature		
Film Material	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	
Polyester	130°C	130°C	270°C	270°C	
Polypropylene	125°C	130°C	260°C	270°C	
Paper	130°C	140°C	270°C	270°C	
Polyphenylene Sulphide	150°C	160°C	270°C	270°C	



Dielectric Film Material	Maximum temperature measured inside the element
Polyester	160°C
Polypropylene	125°C
Paper	160°C
Polyphenylene sulphide	160°C



Temperature monitored inside the capacitor.

Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, however, instead of two baths, there is only one bath with a time from 3 to 10 seconds. In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.















Mounting

Resistance to Vibration and Mechanical Shock

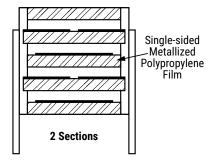
AEC-Q200 Mechanical Stress Tests:

Mechanical Shock	MIL-SDT-202 Method 213	Test condition C Peak value 100 g, duration 6 ms, half-sine-wave (see MIL-HDBK for details)
Vibration	MIL-SDT-202 Method 204	5 g for 20 minutes, 12 cycles each of 3 orientations Use 8"X5" PCB, 0.031" thick. 7 secure points on one 8" side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz.

The capacitors are designed for PCB mounting. The stand-off pipes must be in good contact with the printed circuit board. The capacitor body has to be properly fixed (e.g. clamped or glued).

Construction Detailed Cross Section 2 Sections Single-sided Metallized Polypropylene Film Molded Plastic Molded Plastic Self-Extinguishing Case Case Resin (First Layer) Single-sided Metallized Polypropylene Film (Second Layer) Margin Margin Metal Contact Layer Metal Contact Layer Margin

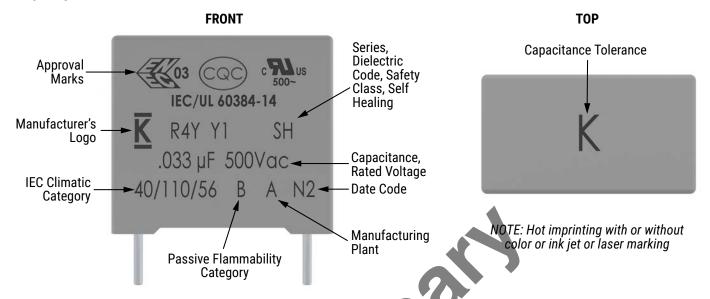
Winding Scheme





Marking

Lead Spacing 15 - 22.5 mm



	Manufacturing Date Code (IEC 60062)											
Year	Code	Year	Code	Year	Code	Month	Code	Month	Code			
2020	М	2027	٧	2034	E	January	1	July	7			
2021	N	2028	W	2035	F	February	2	August	8			
2022	Р	2029	X	2036	G	March	3	September	9			
2023	R	2030	Α	2037	Н	April	4	October	0			
2024	S	2031	В	2038	K	May	5	November	N			
2025	T	2032	C	2039	L	June	6	December	D			
2026	U	2033	D	2040	M							



Packaging Quantities

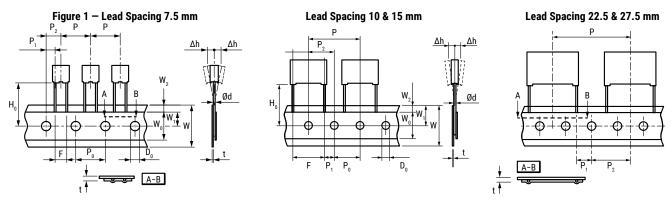
Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads ¹	Lo	ılk ng ads	Standard Reel ø 355 mm	Large Reel ø 500 mm	Ammo Taped	Pizza
Lead And Packaging Code:		00 - JA - JB JE - JH	40 - 50	JM	GY	СК	DQ	НА		
	5.0	11.0	18.0	2,000	1,000	1,250	600	1,250	800	1122
	6.0	12.0	18.0	1,750	900	1,000	500	1,000	680	935
15	7.5	13.5	18.0	1,000	700	800	350	800	500	748
15	8.5	14.5	18.0	1,000	500	650	270	700	440	663
	10.0	16.0	18.0	750	500	550	270	600	380	561
	11.0	19.0	18.0	450	350	400	270	500	340	510
	6.0	15.0	26.5	805	500	450	300	700	464	660
	7.0	16.0	26.5	700	500	450	250	550	380	564
22.5	8.5	17.0	26.5		300	350	250	450	280	468
22.5	10.0	18.5	26.5		300	350	160	350	235	396
	11.0	20.0	26.5		250	200	160	350	217	360
	13.0	22.0	26.5		200	150	130	300	-	300

¹ For lead spacing 22.5 case sizes ≥8.5*17*26.5 the parts are packed in a Pizza box 335*320*34 mm





Lead Taping & Packaging (IEC 60286-2)



Taping Specification

	Symbol	Dimensions (mm)					
Description		Lead Spacing					
		7.5	10.0	15.0	22.5	27.5	Tolerance
Lead wire diameter	d	0.5 - 0.6	0.6	0.6 - 0.8	0.8	0.8	±0.05
Taping lead space	P	12.7	25.4	25.4	38.1	38.1	±1
Feed hole lead space *	P ₀	12.7	12.7	12.7	12.7	12.7	±0.2 **
Centering of the lead wire	P ₁	2.6	7.7	5.2	7.8	5.3	±0.7
Centering of the body	P ₂	6.35	12.7	12.7	19.05	19.05	±1.3
Lead spacing ***	F	7.5	10.0	15.0	22.5	27.5	+0.6/-0.1
Component alignment	Δh	0	0	0	0	0	±2
Component deviation	Δр	0	0	0	0	0	±1
Height of component from tape center	H ₀ ****	18.5	18.5	18.5	18.5	18.5	±0.5
Carrier tape width	W	18	18	18	18	18	+1/-0.5
Hold down tape width	W _o	6.	9	10	10	10	Minimum
Hole position	W ₁	9	9	9	9	9	±0.5
Hold down tape position	W ₂	3	3	3	3	3	Maximum
Feed hole diameter	D _o	4	4	4	4	4	±0.2
Total Tape thickness	t	0.7	0.7	0.7	0.7	0.7	±0.2

^{*} Available also 15 mm.

^{**} Maximum 1 mm on 20 lead spacing.

^{*** 15} mm and 10 mm taped to 7.5 mm (crimped leads) available upon request.

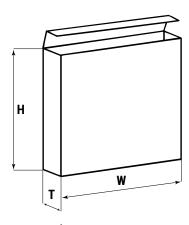
^{****} H_0 = 16.5 mm is available upon request.



Lead Taping & Packaging (IEC 60286-2) cont.

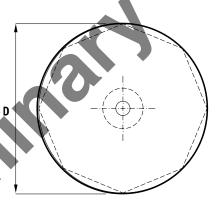
Ammo Specifications

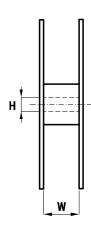
Dimensions (mm)						
Н	W	Т				
360	340	59				



Reel Specifications

Dool Ciro	Dimensions (mm)				
Reel Size	D	Н	W		
Standard	355	30	55 Maximum		
Large	500	25			







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Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicated or that other measures may not be required.

